IN THE CLAIMS:

- 1. (Currently Amended) A chip carrier comprising:
- a base having a periphery;

an inner well having a periphery extending along a length of a the periphery of the base;

and

an outer well extending along a length of a the periphery of the inner well.

- 2. (Original) The chip carrier according to claim wherein the first well and the second well form a flexible structure.
- 3. (Original) The chip carrier according to claim 1 wherein the outer well includes an outer wall and an inner wall and the inner well includes an outer wall coupled to the inner wall of the outer well.
- 4. (Previously Presented) The chip carrier according to claim 1 wherein the base includes an upper surface and wherein the outer well has a first base and the inner well has a second base wherein there is a first distance between the first base and the upper surface and there is a second distance between the second base and the upper surface, the first distance greater than the second distance.

5. (Previously Presented) The chip carrier according to claim 1 further comprising an integrated circuit removably positioned on the base.

Kindly Cancel Claims 6 and 7 without prejudice or disclaimer.

Claim 8-20 (Canceled)

21. (Previously Presented) The chip carrier according to claim 1 further comprising: an upper surface;

an integrated circuit positioned on the base and below the upper surface, the integrated circuit having leads;

wherein the inner well has a base, the leads positioned above the base and below the upper surface.

- 22. (Previously Presented) The chip carrier according to claim 1 wherein the base, the inner well, and the outer well form an integrated circuit carrier and the chip carrier further comprises a plurality of integrated circuit carriers.
- 23. (Previously Presented) The chip carrier according to claim 1 further comprising a cover adapted to hold an integrated circuit in the chip carrier.

- 24. (Previously Presented) The chip carrier according to claim 1 further comprising a cover for holding an integrated circuit in the chip carrier.
 - 25. (Currently Amended) A chip carrier comprising:
 - a base having a periphery;

and

an inner well having a periphery extending along a length of a the periphery of the base;

an outer well extending along a length of a the periphery of the inner well; and the chip carrier adapted to temporarily hold an integrated circuit in the chip carrier.

- 26. (Previously Presented) The chip carrier according to claim 25 wherein the base, the inner well, and the outer well form an integrated circuit carrier and the chip carrier further comprises a plurality of integrated circuit carriers.
- 27. (Previously Presented) The chip carrier according to claim 25 further comprising a cover adapted to hold an integrated circuit in the chip carrier.
- 28. (Previously Presented) The chip carrier according to claim 25 further comprising a cover for holding an integrated circuit in the chip carrier.